BRIGHTEK (EUROPE) Brighten up The Won



# **PRODUCT DATASHEET**



- Ceramic High Power 3535 1.95t Series
- Blue (460-475nm)



## 3535 1.95t Series

## **FEATURES:**

- Package: Ceramic SMT Package with Silicon Lens
  - Forward Current: 350~700mA
- Forward Voltage (typ.): 3.2V
- Luminous Flux (typ.): 30lm@350mA .
- Colour: Blue .
- Wavelength: 460~475nm .
- Viewing angle: 120° •
- Materials:
  - Resin: Silicon (Water Clear) \_
  - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- Grouping parameters: .
  - **Forward Voltage** \_
  - Luminous Flux \_
  - **Dominant Wavelength**
- Soldering methods: Reflow Soldering
- Preconditioning: MSL4 according to J-STD020
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7'')

# N0B56S80Z

3535 1.95t Series

**APPLICATIONS:** 

**Portable Lighting** 

**Outdoor Lighting** 

Indoor Lighting

Industrial Lighting

Plant Grow Light

**Commercial Lighting** 





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## CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	700	mA
Pulse Forward Current	Ipf	1000	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Junction Temperature	Tj	115	°C
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т <sub>stg</sub>	-40~+100	°C
Soldering Temperature	Tsol	260	°C
Thermal Resistance - Junction to Solder Point	$R_{th}$	7	°C/W

 $^{st}$  in the order of Cool White / Warm White

#### Electrical & Optical Characteristics (Ta=25°C)

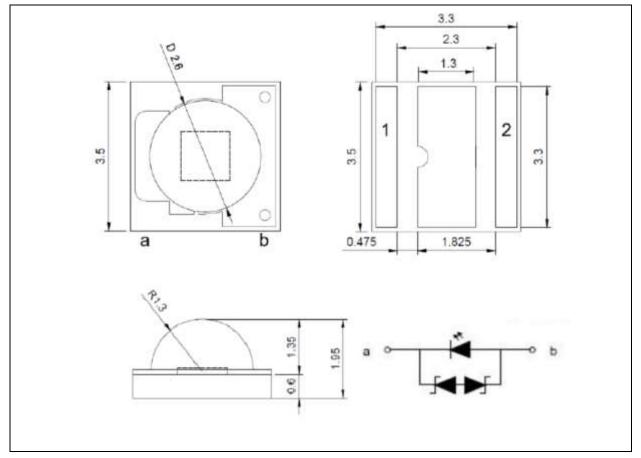
Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	$V_{\text{F}}$	2.8		3.6	V	I <sub>F</sub> =350mA
Luminous Flux	Φv	25		35	lm	I⊧=350mA
Dominant Wavelength	$\lambda_{\text{D}}$	460		475	nm	I⊧=350mA
Viewing Angle	20 <sub>1/2</sub>		120		deg	I <sub>F</sub> =350mA

1. Radiant Flux ( $\Phi_V$ ) ±5%, Forward Voltage (V<sub>F</sub>) ±0.06V, Viewing angle( $2\theta_{1/2}$ ) ±10°



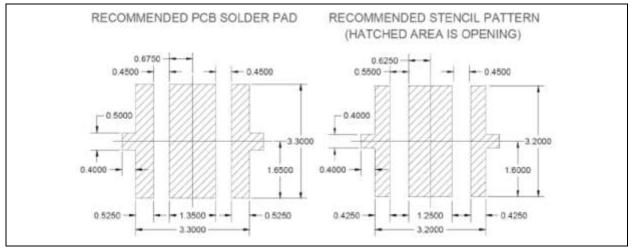
## **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

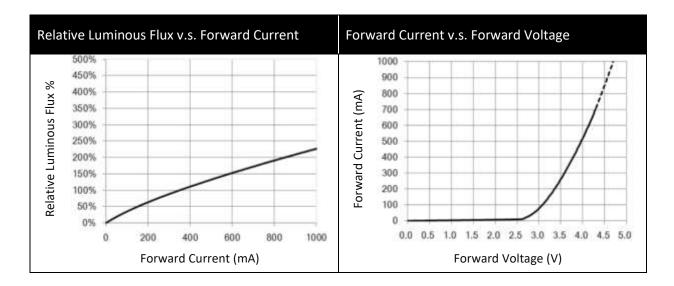
#### Recommended Soldering Pad Dimension:

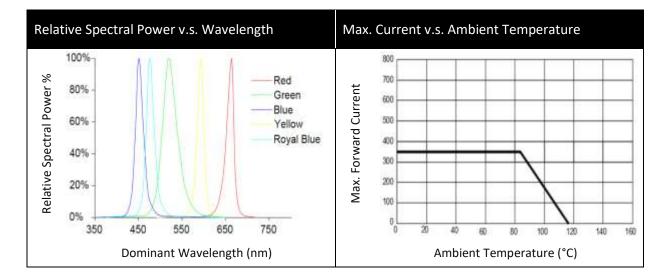


- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.12$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **ELECTRO-OPTICAL CHARACTERISTICS:**







## **BINNING GROUPS:**

Code	Min.	Max.	Unit
V28	2.8	3.0	
V30	3.0	3.2	V
V32	3.2	3.4	V
V34	3.4	3.6	

#### Forward Voltage Classifications (I<sub>F</sub> = 350mA):

#### Luminous Flux Classifications (I<sub>F</sub> = 350mA):

Code	Min.	Max.	Unit
B15	15	20	
B20	20	25	lm
B25	25	30	

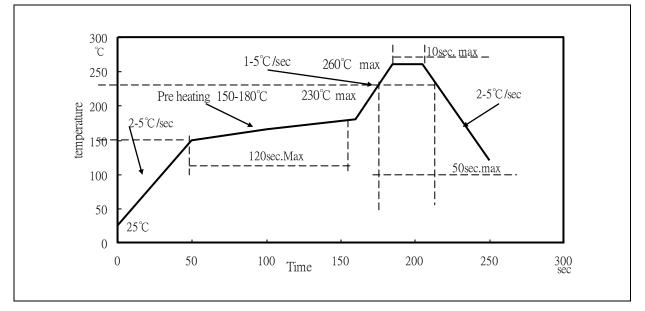
#### Dominant Wavelength Classifications (I<sub>F</sub> = 350mA):

Code	Min.	Max.	Unit
B1	460	465	
B2	465	470	nm
В3	470	475	



## **RECOMMENDED SOLDERING PROFILE:**

#### Reflow Lead-free Solder:



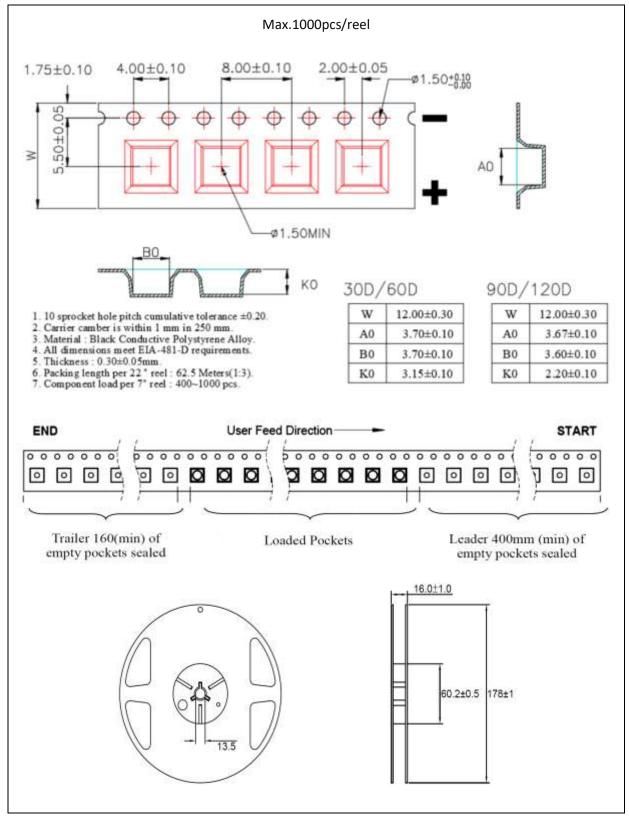
Note:

- 1. Maxima reflow soldering: 3 times.
- 2. The recommend reflow temperature is 240°C. The maxima soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

#### Reel Dimension:



## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

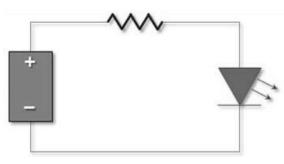
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	17/01/2022	Datasheet set-up.